TOSHIBA Bi-CMOS Digital Integrated Circuit Silicon Monolithic

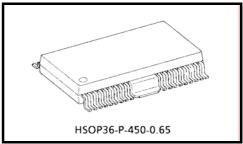
# TB2924FG

Class D, 20 W  $\times$  2-channel (BTL) Low-Frequency Power Amplifier IC

The TB2924FG is an audio output IC that employs the highly efficient class D method, developed for TV and home audio applications.

The TB2924FG eliminates the need for heatsink<sup>(Note)</sup>, thus allowing the design of an end product with a small footprint. It also incorporates a range of features, such as standby and muting, as well as different protective circuits.

### Features





• Output:  $POUT = 13 W \times 2ch$  (typ.) BTL

 $\begin{array}{l} V_{CC} = 12 \ V, \ R_L = 4 \ \Omega, \ THD = 10\%, \ f = 1 \ kHz \\ P_{OUT} = 7.5 \ W \times 2ch \ (typ.) \ BTL \\ V_{CC} = 12 \ V, \ R_L = 8 \ \Omega, \ THD = 10\%, \ f = 1 \ kHz \\ P_{OUT} = 19.5 \ W \times 2ch \ (typ.) \ BTL \\ V_{CC} = 15 \ V, \ R_L = 4 \ \Omega, \ THD = 10\%, \ f = 1 \ kHz \\ P_{OUT} = 21 \ W \times 2ch \ (typ.) \ BTL \\ V_{CC} = 20 \ V, \ R_L = 8 \ \Omega, \ THD = 10\%, \ f = 1 \ kHz \\ \end{array}$ 

- High efficiency: When output is 10 W  $\eta = 88\%$  (V<sub>CC</sub> = 15 V, R<sub>L</sub> = 8  $\Omega$ )
- Distortion: 0.1% (1 W output, f = 1 kHz)
- Gain: 34dB (typ.)
- Small flat package: HSOP36-P-450-0.65
- Muting/standby features
- Thermal AGC features
- Master and slave oscillation frequencies
- Oscillation frequency:  $f_{sw} = 200 \text{ kHz}$  (typ.)
- Operating supply voltage range:  $V_{CC}$  (opr) = 11 V to 18V ( $T_{opr} = 0^{\circ}C$  to 75°C), (4  $\Omega$ )  $V_{CC}$  (opr) = 11.4 V to 18 V ( $T_{opr} = -20^{\circ}C$  to 75°C)
- Operating supply voltage range:  $V_{CC}$  (opr) = 11 V to 20V ( $T_{opr} = 0^{\circ}C$  to 75°C), (8  $\Omega$ )  $V_{CC}$  (opr) = 11.4 V to 20 V ( $T_{opr} = -20^{\circ}C$  to 75°C)
- Protective circuits: thermal shutdown, short-circuit protection (load)

These protection functions are intended to avoid some output short circuits or other abnormal conditions temporarily.

These protect functions do not warrant to prevent the IC from being damaged.

In case of the product would be operated with exceeded guaranteed operating ranges, these protection features may not operate and some output short circuits may result in the IC being damaged.

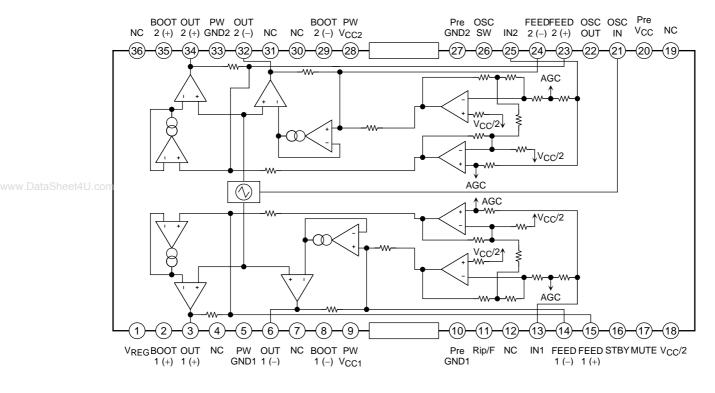
The TB2924FG does not contain protection circuitry for shorts against VCC and ground. Extra care should be exercised when output pins serve as line output or adjacent pins are shorted together on the board.

Note: Generally, the average power of the audio signal constitutes only one-fifth to one-tenth of the maximum output power, and in practice, will not exceed the permissible loss. However, care should be exercised so that it will not be really exceeded, considering the board's thermal resistance, ambient temperature, average output power and so forth. Toshiba has verified that the TB2924FG works properly without a heatsink on the Toshiba PC board for up to 10-watt by 2-channel output typical ( $V_{CC} = 15 \text{ V}$ ,  $R_L = 8 \Omega$ , THD = 10%, f = 1 kHz) with a sine-wave input.

This product are sensitive to electrostatic discharge. When handling this product, protect the environment to avoid electrostatic discharge.( $MM:\pm 200V \text{ OK}, HBM:\pm 1500V \text{ OK}$ )

Install the product correctly. Otherwise, it may result in break down, damage and/or degradation to the product or equipment.

## Pin Assignment and Block Diagram



\*: Some of the functional blocks, circuits, or constants in the block diagram may be omitted or simplified for explanatory purpose.

## **Pin Functions**

Pin No.	Symbol	Description			
1	V <sub>REG</sub>	Reference supply voltage			
2	BOOT1 (+)	CH1 bootstrap pin (+)			
3	OUT1 (+)	CH1 main amplifier output pin (+)			
4	NC	No-connection pin (not connected inside the IC)			
5	PW GND1	ND for CH1 main amplifier output stage			
6	OUT1 (–)	CH1 main amplifier output pin (-)			
7	NC	No-connection pin (not connected inside the IC)			
8	BOOT1 (–)	CH1 bootstrap pin (-)			
9	PW V <sub>CC1</sub>	Power supply pin for CH1 main amplifier output stage			
10	Pre-GND1	Signal GND			
11	Rip/F	Ripple filter pin			
12	NC	No-connection pin (not connected inside the IC)			
13	IN1	CH1 main amplifier input pin			
14	FEED1 (-)	CH1 main amplifier feedback pin (-)			
15	FEED1 (+)	CH1 main amplifier feedback pin (+)			
16	STBY	Standby control pin			
17	MUTE	Muting control pin			
18	V <sub>CC</sub> /2	Midpoint potential pin			
19	NC	No-connection pin (not connected inside the IC)			
20	Pre V <sub>CC</sub>	Signal power supply pin			
21	OSC IN	PWM oscillation frequency input pin			
22	OSC OUT	PWM oscillation frequency output pin			
23	FEED2 (+)	CH2 main amplifier feedback pin (+)			
24	FEED2 (–)	CH2 main amplifier feedback pin (-)			
25	IN2	CH2 main amplifier input pin			
26	OSC SW	Oscillator on/off switch pin			
27	Pre-GND2	Signal GND			
28	PW V <sub>CC2</sub>	Power supply pin for CH2 main amplifier output stage			
29	BOOT2 (-)	CH2 bootstrap pin (-)			
30	NC	No-connection pin (not connected inside the IC)			
31	NC	No-connection pin (not connected inside the IC)			
32	OUT2 (-)	CH2 main amplifier output pin (-)			
33	PW GND2	GND for CH2 main amplifier output stage			
34	OUT2 (+)	CH2 main amplifier output pin (+)			
35	BOOT2 (+)	CH2 bootstrap pin (+)			
36	NC	No-connection pin (not connected inside the IC)			

## Supplementary Explanation (preliminary)

### <Control switches>

### 1. Pin 17 (muting switch)

- Enable or disable audio muting.
- The input amplifier is switched to a dummy amplifier within the IC, so that the audio output is muted with the amplifier still operating (PWM switched operation with 50% duty ratio).
- Pin 17 outputs a voltage of approximately 2.4 V (approx. 4 VF) when open, while VTH for the built-in switch is lower than 1.8 V. Leaving the pin open, therefore, disables muting.
- Logic

"H" or open: Demute "L" (GND): Mute on

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### 2. Pin 16 (standby switch)

- When the voltage on pin 16 becomes 1.8 V or higher, the bias circuit activates, enabling the IC to operate.
- Logic
   "H": IC active
   "L" (GND): IC standby on

### <Others>

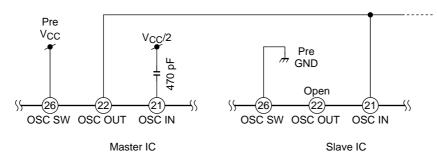
### 3. Thermal AGC Function and Thermal Shutdown Circuit

- If the chip temperature exceeds the junction temperature (150°C min.), the thermal AGC function attenuates the input signal to maintain the chip temperature below the junction temperature.
- If the chip temperature further increases, the thermal shutdown circuit activates. The chip recovers from the thermal shutdown state once the chip temperature falls below the junction temperature.

### 4. Master and Slave Oscillation Frequencies (OSC IN, OSC OUT, OSC SW)

- When configuring a multichannel amplifier system with three or more channels, the oscillation frequency for a single IC can be used as a master and supplied to other ICs to prevent a beat due to a difference among switching frequencies.(Max.6ch (3ICs))
- The oscillators for slave ICs should be turned off using the OSC SW pin. "H": Turn the oscillator on "L" (GND): Turn the oscillator off

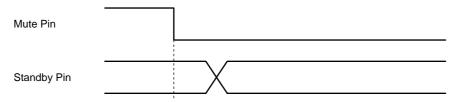
(Example with multiple ICs)



### 5. Reduction of Pop Noise Generated when Turning on and Off the Power Supply

• To reduce pop noise, it is recommended to enable muting by setting pin 17 (mute switch) to logic low before turning on or off the power supply or standby mode.

When turning on or off the standby mode (When the power supply is not turned on or off)



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Turn on or off the standby mode after turning on muting.

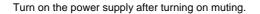
When the power supply is off

Mute Pin					
Standby Pin					
Power Supply Pin					

Turn off the power supply after turning on muting. Don't turn off the standby mode before turning off the power supply.

When the power supply is on

Mute Pin		
Standby Pin		
	i	



Timing charts may be simplified for explanatory purpose.

### 6. Board Mounting Consideration

The switching of the TB2924FG is controlled with a rectangular-wave signal of approximately 200 kHz (typical). It is recommended to place the TB2924FG far from the tuner portion, etc. that might be affected.

## Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit	
Power supply	V <sub>CC</sub>	23	V	
Output current	I <sub>o(peak)</sub>	8	А	
Power dissipation	PD	14.7 (Note)	W	
Operating temperature	T <sub>opr</sub>	-20 to 75	°C	
Storage temperature	T <sub>stg</sub>	-55 to 150	°C	

Note: When the IC is used at 25°C or higher with infinite heat sink, reduce 117.6 mW per 1°C.

The absolute maximum ratings of a semiconductor device are a set of specified parameter values, which must not be exceeded during operation, even for an instant.

If any of these rating would be exceeded during operation, the device electrical characteristics may be irreparably altered and the reliability and lifetime of the device can no longer be guaranteed.

Moreover, these operations with exceeded ratings may cause break down, damage and/or degradation to any other equipment.

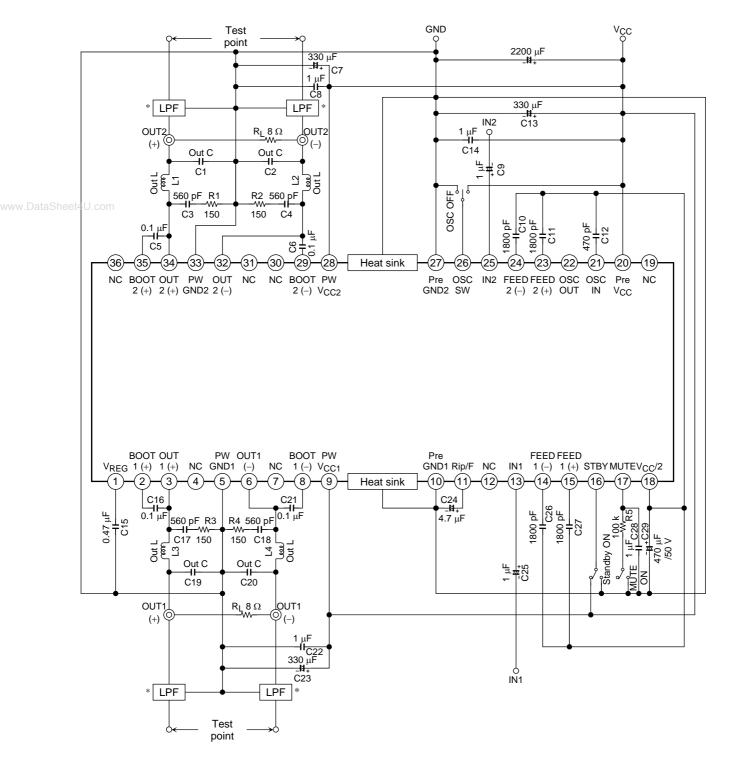
Applications using the device should be designed such that each maximum rating will never be exceeded in any operating conditions.

Before using, creating and/or producing designs, refer to and comply with the precautions and conditions set forth in this documents.

# Electrical Characteristics 1 (unless otherwise specified, $V_{CC}$ = 15 V, f = 1 kHz, $R_g$ = 600 $\Omega$ , $R_L$ = 8 $\Omega$ , Ta = 25°C)

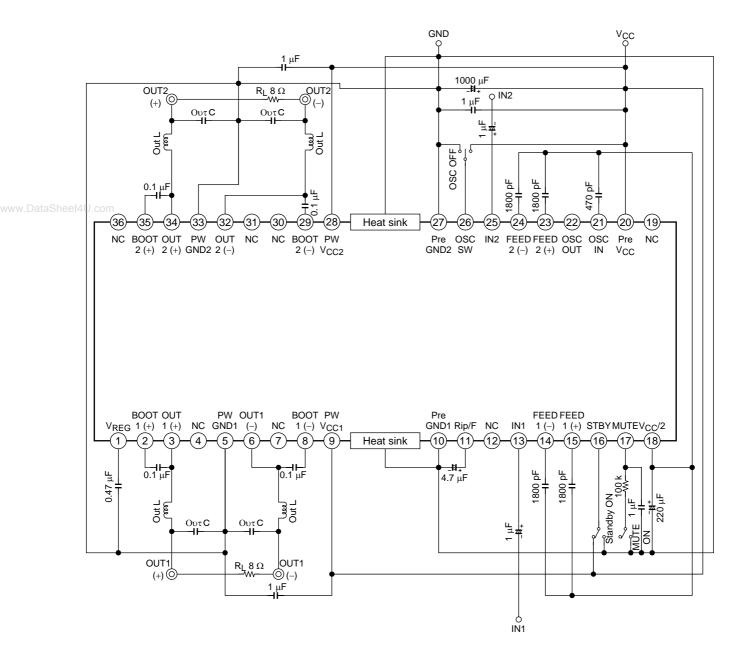
Characteristics	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit	
Quiescent supply current	ICCQ	1	Vin = 0	_	55	70	mA	
	Р <sub>ОUT</sub> (1)	1	THD = 10%	9	10.5			
	P <sub>OUT</sub> (2)	1	V <sub>CC</sub> = 18 V, THD = 10%	12.5	15	_		
Output power	P <sub>OUT</sub> (3)	1	$\label{eq:RL} \begin{array}{l} R_{L} = 4 \; \Omega, \; V_{CC} = 12 \; V, \\ THD = 10\% \end{array}$	11.5	13	_	w	
	P <sub>OUT</sub> (4)	1	$\label{eq:RL} \begin{array}{l} R_{L} = 4 \ \Omega, \ V_{CC} = 15 \ V, \\ THD = 10\% \end{array}$	18	19.5	_		
Efficiency	η (1)	1	P <sub>OUT</sub> = 10 W	80	88	_	%	
Enciency	η (2)	1	P <sub>OUT</sub> = 1.0 W	63	66	_		
Total harmonics distortion	THD	1	P <sub>OUT</sub> = 1 W	_	0.1	0.3	%	
Voltage gain	GV	1	V <sub>OUT</sub> = 0.775 Vrms	32.5	34	35.5	dB	
Channel Balance	СВ	1	V <sub>OUT</sub> = 0.775 Vrms	-1.0	0	1.0	dB	
Input impedance	R <sub>IN</sub>	1	—	_	30	_	kΩ	
Crosstalk	C.T.	1	$R_g = 10 k\Omega,$ V <sub>OUT</sub> = 0.775 Vrms	-56	-65	_	dB	
Output noise voltage	V <sub>NO</sub>	1	$R_g = 10 \text{ k}\Omega,$ B.W. = DIN AUDIO	_	0.2	0.3	mVrm	
Switching frequency	f <sub>sw</sub>	1	—	160	200	300	kHz	
Standby supply current	I <sub>STB</sub>	1	During standby		0.2	0.34	mA	
Power transistor ON resistance	R <sub>DS-ON</sub>	1	—		0.3	_	Ω	
Mute attenuation level	ATT <sub>MUTE</sub>	1	0dB = V <sub>OUT</sub> = 0.775 Vrms	-71	-78	_	dB	
Control voltage for pin 17 muting	V <sub>MUTE off</sub>	1	Not muted	1.8	_	V <sub>CC</sub>	V	
switch	V <sub>MUTE on</sub>	1	Muted	GND		0.9		
Control voltage for pin 16 standby switch	V <sub>STB off</sub>	1	Amplifier operating (not standby)	1.8		V <sub>CC</sub>	V	
SWILCH	VSTB on	1	Amplifier stopped (standby on)	GND		1.1		
Control voltage for pin 26 oscillator	V <sub>OSC on</sub>	1	Oscillator operating	1.8	_	V <sub>CC</sub>	v	
on/off switch	VOSC off	1	Oscillator stopped	GND		0.5	v	

# Test Circuit Diagram 1



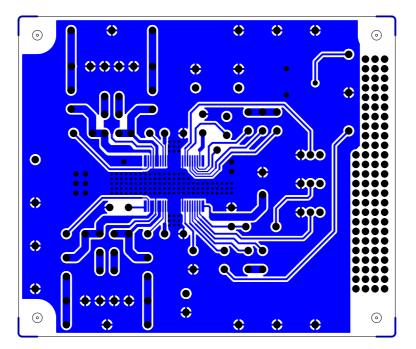
- \*: Output L (4 Ω): 10 μH (A7502BY-180M: TOKO, INC.)
- \*: Output C (4 Ω): 1.0 μF
- \*: Output L (8  $\Omega)$ : 18  $\mu H$  (A7502BY-180M: TOKO, INC.)
- \*: Output C (8 Ω): 0.47 μF
- \*: Components in the test circuits are only used to obtain and confirm the device characteristics. These components and circuits do not warrant to prevent the application equipment from malfunction or failure.
- \*: In addition to the low-pass filters (chebyshev LPFs) shown above, a fourth low-pass filter with a cut-off frequency of 30 kHz is used for device characterization.

# **Example Application Circuit**



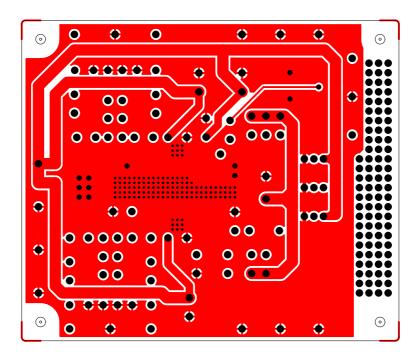
- \*: Output L (4  $\Omega$  ): 10  $\mu\text{H}$  (A7502BY-180M: TOKO, INC.)
- \*: Output C (4 Ω): 1.0 μF
- \*: Output L (8 Ω): 18 μH (A7502BY-180M: TOKO, INC.)
- \*: Output C (8 Ω): 0.47 μF
- \*: The application circuits shown in this document are provided for reference purposes only. Especially, thorough evaluation is required on the phase of mass production design. Toshiba dose not grant the use of any industrial property rights with these examples of application circuits.
- \*: When no signal is present, the power supply current varies with the characteristics of the output inductance (Out L).
- \*: For all capacitors that are not indicated by the electrolytic capacitor symbol, use ceramic capacitors with an appropriate withstand voltage.

# Toshiba's PC Board Layout (Mounting side)

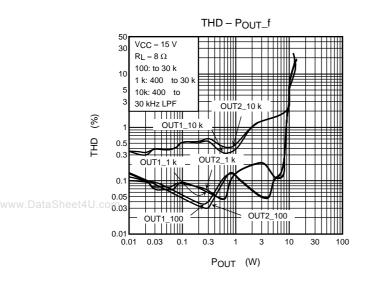


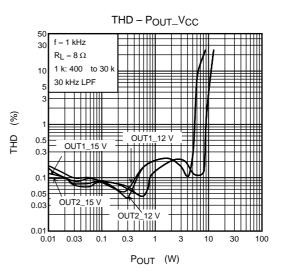
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# (Back side)

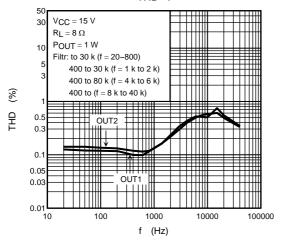


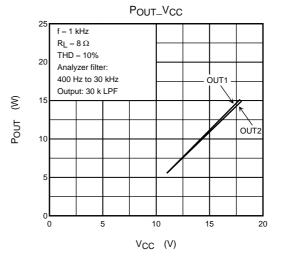
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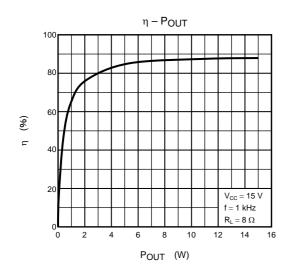


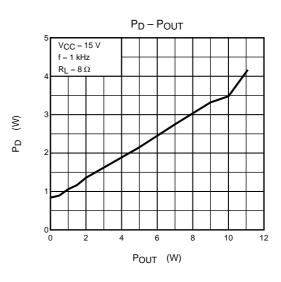


THD –f

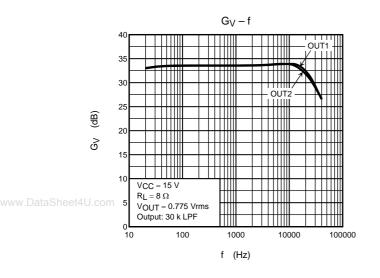


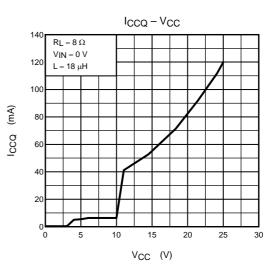


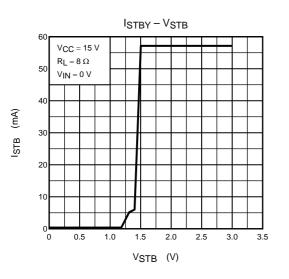


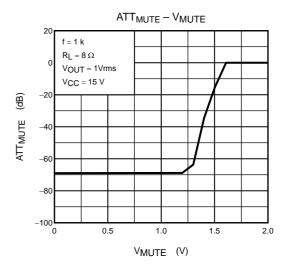


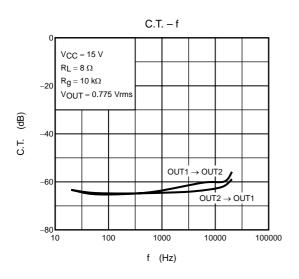
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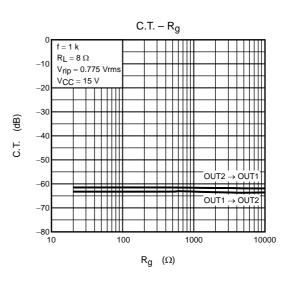


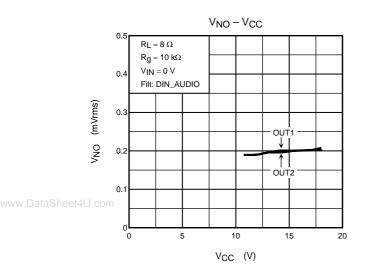


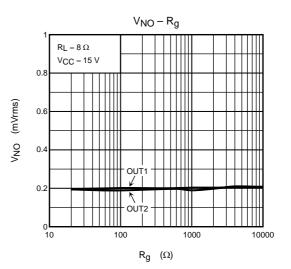


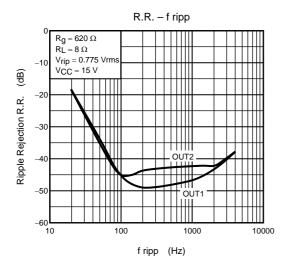


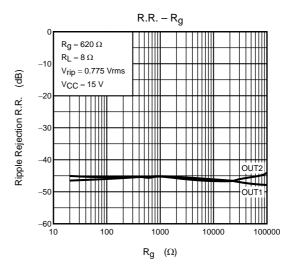


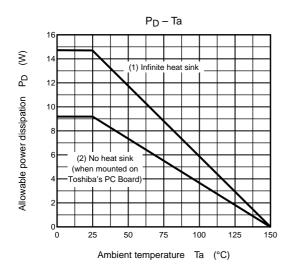








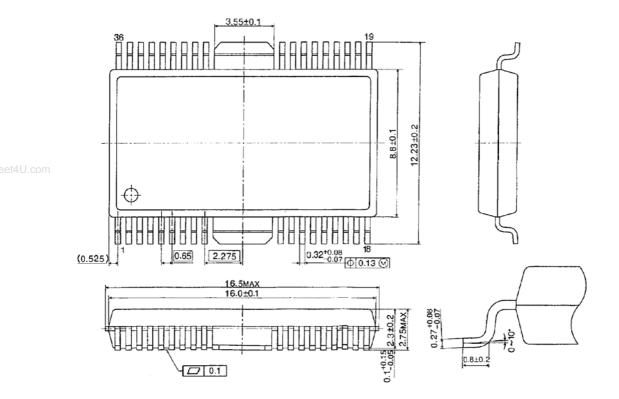




## **Package Dimensions**

HSOP36-P-450-0.65

Unit: mm



Weight: 0.85 g (typ.)

### **Strong Electrical and Magnetic Fields**

Devices exposed to strong magnetic fields can undergo a polarization phenomenon in their plastic material, or within the chip, which gives rise to abnormal symptoms such as impedance changes or increased leakage current. Failures have been reported in LSIs mounted near malfunctioning deflection yokes in TV sets. In such cases the device's installation location must be changed or the device must be shielded against the electrical or magnetic field. Shielding against magnetism is especially necessary for devices used in an alternating magnetic field because of the electromotive forces generated in this type of environment.

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	About solderability, following conditions were confirmed				
	Solderability				
	<ul> <li>(1) Use of Sn-37Pb solder Bath <ul> <li>solder bath temperature = 230°C</li> <li>dipping time = 5 seconds</li> <li>the number of times = once</li> <li>use of R-type flux</li> </ul> </li> </ul>				
Sheel	<ul> <li>↓U.○(2) Use of Sn-3.0Ag-0.5Cu solder Bath</li> <li>· solder bath temperature = 245°C</li> <li>· dipping time = 5 seconds</li> <li>· the number of times = once</li> <li>· use of R-type flux</li> </ul>				

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